

Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A Method method for producing an irreversible storage medium comprising including an array of memory cells, each memory cell comprising including one zone of an active layer arranged between first and second conductors, binary information stored in the each memory cell being determined by the electrical conducting state of the of a corresponding zone, the method comprising:

assembly of assembling a blank storage medium having an active layer the active layer, which is in an initial insulating state, state;

production of producing a stamping die having a stamping pattern that corresponds to the binary information to be stored, stored; and

stamping of the storage medium using the stamping die so as to make predetermined zones of the active layer electrically conductive by means of localised plastic deformation.

2. (Currently Amended) The Method method according to claim 1, wherein the active layer is formed by a charged resin.

3. (Currently Amended) The Method method according to claim 1, wherein assembly of a the assembling the blank storage medium successively comprises includes:

[-] deposition, depositing on a substrate, of substrate, a first conducting layer and of two oppositely doped semi-conducting layers, layers;

[-] etching of the a stack formed by the first conducting layer and the two semi-conducting layers so as to obtain a first array of parallel strips, strips;

[-] filling the a space between the strips of the first array of parallel strips so as to create a common plane with the strips of the first array of parallel strips, strips;

- [-] ~~deposition of depositing~~ the active layer on ~~said the common plane, plane;~~
- [-] ~~deposition of depositing~~ a second conducting layer on the active ~~layer, layer;~~
etching ~~of~~ the second conducting ~~layer, layer~~ so as to obtain a second array of parallel strips perpendicular to the strips of the first array of ~~strips, strips;~~ and
filling the space between the strips of the second array of parallel strips.

4. (Currently Amended) The Method method according to claim 3, wherein the space between the strips of the first and/or second array of parallel strips is filled by means of a technique using a planarization resin.

5. (Currently Amended) The Method method according to claim 3, wherein the space between the strips of the first and/or second array of parallel strips is filled by means of a mechanical-chemical polishing step.

6. (Currently Amended) The Method method according to claim 1, wherein ~~production of the producing~~ the stamping die successively ~~comprises includes~~:

- [-] ~~deposition of depositing~~ a photoresist on an intermediate ~~substrate, substrate;~~
- [-] ~~etching, etching~~ in the ~~photoresist, of photoresist,~~ an array of elementary zones having a configuration corresponding to the stamping ~~pattern, pattern;~~
- [-] ~~electrolytic deposition, electrolytically depositing~~ on the intermediate substrate and the ~~photoresist, of photoresist~~ a metal constituting the stamping ~~die, die;~~
- [-] ~~detachment of detaching~~ the stamping die from the intermediate ~~substrate, substrate;~~
and
- [-] ~~removal of removing~~ the residues of ~~the~~ photoresist from the stamping die.

7. (Currently Amended) An Irreversible irreversible storage medium,
medium obtained by means of a formed by the method according to claim 1.